

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5854125

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
RAKESH JAIN	06/12/2018
JINWEI YANG	06/28/2018
MAXIM S SHATALOV	07/01/2018
ALEXANDER DOBRINSKY	06/08/2018
BRANDON ROBINSON	06/27/2018
RECEIVING PARTY DATA	
Name:	Sensor Electronic Technology, Inc.
Street Address:	110 Atlas Ct.
City:	Columbia
State/Country:	SOUTH CAROLINA
Postal Code:	29209
PROPERTY NUMBERS Total: 2	
Property Type	Number
Application Number:	62527990
Patent Number:	10490697
CORRESPONDENCE DATA	
Fax Number:	(518)514-1360
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	5187553658
Email:	national@labattlaw.com
Correspondent Name:	JOHN W LABATT
Address Line 1:	PO BOX 630
Address Line 4:	VALATIE, NEW YORK 12184
ATTORNEY DOCKET NUMBER:	SETI-0084-CIP2
NAME OF SUBMITTER:	JOHN W. LABATT
SIGNATURE:	/John W. LaBatt/
DATE SIGNED:	12/06/2019
Total Attachments: 15	

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ASSIGNMENT OF PATENT APPLICATIONS

This Agreement is entered into and effective as of 8 June 2018, by and between Sensor Electronic Technology, Inc., a business entity formed under the laws of New York, having an address of 110 Atlas Ct., Columbia, SC 29209 (Assignee) and the below named Inventors (Assignors).

WHEREAS each Assignor has contributed to the conception of an invention and/or improvement described in one or more of the following, collectively referred to as the "Patent Applications":

- (a) a U.S. Provisional Application No. 62/527,990, filed on 30 June 2017; and
- (b) a nonprovisional utility patent application for filing in the United States, titled "Epitaxy Technique for Growing Semiconductor Compounds" and identified as Attorney Docket No. SETI-0084-CIP2-US, at LaBatt, LLC, PO Box 630, Valatie, NY 12184; and
- (c) any and all applications claiming the benefit of any of the above-referenced applications and any and all continuations, continuations-in-part, divisionals, and renewals of and substitutes for any of the above-referenced applications;

WHEREAS Assignors desire to sell, assign, and transfer all of their rights, title, and interest, for all countries in and to the Patent Applications and the inventions and improvements described therein to Assignee; and

WHEREAS Assignee desires to obtain all of the rights title, and interest, for all countries in and to the Patent Applications and the inventions and improvements described therein as the sole owner of the Patent Applications.

NOW THEREFORE, for and in consideration of good and valuable consideration, the receipt and sufficiency of which is hereby expressly acknowledged, the parties agree as follows:

1. Assignors hereby confirm previous assignment(s) and, to the extent the previous assignment(s) is (are) insufficient, hereby sell, assign, and otherwise transfer unto Assignee, and its successors, assigns and legal representatives, the rights, title and interest, for all countries in and to the Patent Applications and the inventions and improvements described therein and any and all rights and privileges under any and all Letters Patent that may be granted therefor in any country, and any reissues, or reexaminations, or extensions of any such Letters Patent.
2. Assignors request that any and all Letters Patent for the inventions and improvements described in the Patent Applications be issued to the Assignee, its successors, assigns and legal representatives, or to such nominees as the Assignee may designate.
3. Assignors authorize and empower the Assignee, its successors, assigns and legal representatives or nominees, to invoke and claim for any Patent Application or other form of protection for the inventions and improvements described in the Patent Applications, the benefit of the right of priority provided by the International Convention for the Protection of Industrial Property, as amended, or by any convention which may henceforth be substituted for it, and to

invoke and claim such right of priority without further written or oral authorization from the Assignors.


4. Assignors hereby consent that a copy of this Agreement shall be deemed a full legal and formal equivalent of any assignment, consent to file, or like document, which may be required in any country for any purpose and more particularly as proof of the right of the Assignee, its successors, assigns and legal representatives, or to such nominees as the Assignee may designate to claim the aforesaid benefit of the right of priority provided by the International Convention or any convention which may henceforth be substituted for it.

5. Assignors covenant with the Assignee, its successors, assigns and legal representatives, that the rights and property herein conveyed are free and clear of any encumbrance, and that Assignors have full right to convey the same as herein expressed.

6. This Agreement may be executed in any number of counterparts, each of which shall be deemed an original but all of which together shall constitute one and the same agreement.

[Signature page follows]

IN WITNESS WHEREOF, the parties have executed this agreement below.

Signature: /  / Date: 06/12/18
Rakesh Jain, an individual residing in Columbia, SC, US

Signature: / _____ / Date: _____
Wenhong Sun, an individual residing in Lexington, SC, US

Signature: / _____ / Date: _____
Jinwei Yang, an individual residing in Columbia, SC, US

Signature: / _____ / Date: _____
Maxim S. Shatalov, an individual residing in Columbia, SC, US

Signature: / _____ / Date: _____
Alexander Dobrinsky, an individual residing in Silver Spring, MD, US

Signature: / _____ / Date: _____
Remigijus Gaska, an individual residing in Columbia, SC US

Signature: / _____ / Date: _____
Michael Shur, an individual residing in Vienna, VA, US

Signature: / _____ / Date: _____
Brandon Robinson, an individual residing in Columbia, SC, US

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WHEREAS Assignors desire to sell, assign, and transfer all of their rights, title, and interest, for all countries in and to the Patent Applications and the inventions and improvements described therein to Assignee; and

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invoke and claim such right of priority without further written or oral authorization from the Assignors.

4. Assignors hereby consent that a copy of this Agreement shall be deemed a full legal and formal equivalent of any assignment, consent to file, or like document, which may be required in any country for any purpose and more particularly as proof of the right of the Assignee, its successors, assigns and legal representatives, or to such nominees as the Assignee may designate to claim the aforesaid benefit of the right of priority provided by the International Convention or any convention which may henceforth be substituted for it.

5. Assignors covenant with the Assignee, its successors, assigns and legal representatives, that the rights and property herein conveyed are free and clear of any encumbrance, and that Assignors have full right to convey the same as herein expressed.

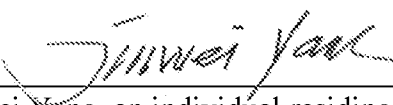
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Signature: / _____/ Date: _____
Wenhong Sun, an individual residing in Lexington, SC, US

Signature: /  _____/ Date: 6/28/2018
Jinwei Yang, an individual residing in Columbia, SC, US

Signature: / _____/ Date: _____
Maxim S. Shatalov, an individual residing in Columbia, SC, US

Signature: / _____/ Date: _____
Alexander Dobrinsky, an individual residing in Silver Spring, MD, US

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WHEREAS Assignee desires to obtain all of the rights title, and interest, for all countries in and to the Patent Applications and the inventions and improvements described therein as the sole owner of the Patent Applications.

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Jinwei Yang, an individual residing in Columbia, SC, US

Signature: / **Max Shatalov** / Date: 07/01/2018
Maxim S. Shatalov, an individual residing in Columbia, SC, US

Digitally signed by Max Shatalov
DN: cn=Max Shatalov, email=shatalov@gmail.com
reason: I have reviewed this document
location: Columbia, SC
date: 2018-07-01 23:50:30

Signature: / _____/ Date: _____
Alexander Dobrinsky, an individual residing in Silver Spring, MD, US

Signature: / _____/ Date: _____
Remigijus Gaska, an individual residing in Columbia, SC US

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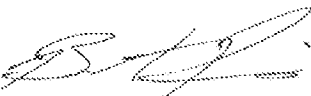
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